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## Storing electronic information on semi-metal nanoparticles

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This paper presents the use of selenium nanoparticles for applications in information storage in two-terminal electronic memory devices. Selenium is a semi-metal with interesting electronic and optical properties that have seldom been studied in terms of electronic memory. In this study, selenium nanoparticles have been demonstrated as an embedded charge storage layer between the silicon oxide tunnel layer and the silicon nitride blocking layer. The electrical characterization demonstrates clear evidence that charge storage occurs, and that the presence of nanoparticles is indispensable. AFM images show that selenium nanoparticles are almost uniformly distributed on a silicon substrate having a thin silicon dioxide tunnelling layer, and the electrical retention measurement shows potential for long-term data storage.

## Introduction

The past few decades have seen a steady rise in the area of emerging non-volatile electronic memory devices. A surge in popularity in this field has led to several works being published about new materials such as metal-oxides,<sup>1,2</sup> perovskites,<sup>3</sup> chalcogenides,<sup>4</sup> and polymer nanocomposites.<sup>5–8</sup> Several studies have introduced newer device structures<sup>1,9–12</sup> and even newer techniques of device fabrications.<sup>12–16</sup> However, the translation of much of the innovative novel work that has been done in the past into the progress in the field has been slow due to issues related to device-to-device variation and lack of repeatability.<sup>17</sup> Several research groups have worked on the same system and similar device structures but the results in regard to the role of nanoparticles in conduction switching from these studies have been quite unclear.<sup>18–20</sup> Several models, such as electric field induced charge transfer, polymer doping, and Simon–Verderber mechanism, have been put forward in the past to explain the device operation; while these succeed in explaining certain facets of the device behavior, several other aspects remain unclear,<sup>21–23</sup> for example, questions such as why device switching affects the repeatability as the ON/OFF ratio increases and the role of the nanoparticles in the process of conduction switching. Since these questions have been discussed in detail in our previous work,<sup>24</sup> this work is limited in its full discussion.

The focus of this study is to further examine and understand the charge storage mechanism by fabricating a selenium nanoparticle-based memory device. Selenium is an interesting material due to its photoelectric conductivity and has the ability

to change its resistance on exposure to light.<sup>24</sup> Selenium has been used in various applications due to its enhanced photoelectric response. Recently, 2D nanoflakes of selenium were investigated for applications in self-powered photodetectors<sup>25</sup> and ultrafast photonic applications.<sup>26</sup> Some materials such as tellurene have poor photoelectric response and are improved by blending with selenium for applications in photodetectors.<sup>27</sup> Bulk selenium has been used for quite a while in photocopiers as a charge-trap layer. Due to the enhanced photoresponse of selenium, its use in charge storage devices such as memory devices will allow the development of photonic memory devices, where the data is light written and erased, which is ultrafast and also energy efficient. The photosensitive resistance of selenium is of interest to trap charges and uses an electric field for printing application. This has been widely attributed to the differences in hole and electron mobility in the material.<sup>28,29</sup> This study focuses on a similar principle, albeit the application of long-term storage of charges. It can be safely argued that the confined nanostructures of selenium would have enhanced charge trapping ability compared to bulk selenium.

However, most importantly, the work function of selenium makes it particularly attractive for non-volatile electronic memory applications. The delicate balance of the work function plays a significant role in the effective storage of information; a higher work function leads to a reduction in the barrier potential, which favors low voltage programming and additionally offers a large barrier that prevents the loss of data.<sup>30</sup> This factor makes the use of gold (Au) and platinum (Pt) very desirable, but a careful study of selenium unravels the benefits over the former elements in this regard and may eliminate the use of expensive metals. Selenium has a work of function of 5.1 eV,<sup>31</sup> which is greater than or closer to metals such as gold (5.1 eV), nickel

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(4.96 eV), silver (4.33 eV), or aluminium (4.24 eV).<sup>30</sup> Apart from the work function, selenium is not easily oxidized and can be deposited using simple thin film deposition technique such as thermal evaporation.<sup>32</sup>

## Experimental details

### Device structure

The device structure constitutes of a modified three-layer (3L) structure, wherein a semi-metal nanoparticle layer would be embedded within an insulator/semiconductor matrix. In this study, selenium nanoparticles have been laid between two dielectric layers, namely, silicon dioxide ( $\text{SiO}_2$ ) and silicon nitride ( $\text{SiN}_x$ ) (refer Fig. 1). The silicon nitride layer is intended to be thick so that charge leakage would be highly unlikely; therefore, it is labelled as the blocking layer. Silicon oxide, on the other hand, is known as the tunnelling layer and, as the name suggests, is intended for the purpose of charge injection in the form of tunnelled charges when an external voltage is applied.

### Device fabrication

The charge storage material used in this work is selenium nanoparticles (SeNPs) deposited by thermal evaporation of selenium (purity  $\geq 99.999\%$ ) using a thermal evaporator (Edwards Auto-306, Se is purchased from Sigma-Aldrich). Evaporation was performed at  $0.1 \text{ nm s}^{-1}$  until a thickness of 5 nm was achieved. It is worth mentioning that the thickness reported here reflects the mass thickness of Se, as determined by the quartz crystal microbalance attached to a film thickness monitor. This does not reflect the nanoparticle size of selenium. The radius of nanoparticles is about  $100 \text{ nm} \pm 18 \text{ nm}$ , which as is also seen in the AFM images included later in this manuscript. The metal-insulator-semiconductor (MIS) devices were fabricated on boron-doped p-Si wafers ( $500 \mu\text{m}$ ,  $1\text{--}20 \text{ Ohm per cm}$ ) with Al back

ohmic contact. The sandwich structure above the silicon surface with Se-NPs (charge storage device) and without Se-NPs (reference device) was achieved with two dielectric insulator thin films, namely, silicon oxide ( $\text{SiO}_2$ ) and silicon nitride ( $\text{SiN}_x$ ). The thickness of the  $\text{SiO}_2$  layer was 2 nm, which is used in this work as the tunnelling layer to allow the tunnelling of charge carriers, and the thickness of the  $\text{SiN}_x$  layer was 100 nm, which is used in this work as a charge blocking layer. The details of the deposition process conditions of each layer are summarized in Table 1. Device structures are as follows: reference device Al/p-Si/ $\text{SiO}_2$ / $\text{SiN}_x$ /Al and charge storage device Al/p-Si/ $\text{SiO}_2$ /Se-NPs/ $\text{SiN}_x$ /Al. Top Al electrode was deposited with the use of a circular-hole (diameter 1.5 mm) shadow mask. The reference device is also commonly termed as the control device in the literature, which does not have a charge storage material.

### Device characterization

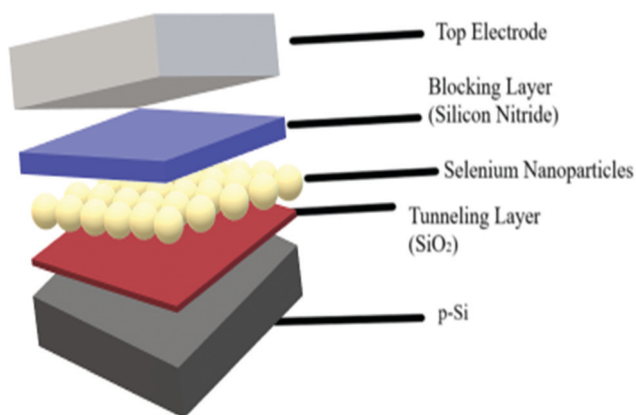
The surface morphology of the layers and NPs were examined with the use of a PISA XE-100 (Park Systems) scanning probe microscope in the non-contact tapping mode. Due to Se being photoconductive and since few of its properties can change with incident light, the light source was switched off 30 min before starting the scanning process in the AFM; however, the laser was on but does not affect the morphological investigation conducted in this work. Current-voltage ( $I$ - $V$ ), capacitance-voltage ( $C$ - $V$ ), and capacitance-time ( $C$ - $T$ ) measurements were performed with a computer-controlled HP-4140B picoammeter and an HP-4192A Impedance analyzer. All measurements were undertaken in an EM-shielded dark box probe station at room temperature.

## Background

This study focuses on the charge trapping mechanism in nanoparticles sandwiched between insulating layers and exploration of charge trapping in non-volatile memory devices. Charge trapping may result in bistability. Bistability refers to the property of devices to occupy different conduction levels under the influence of an external stimulus (in our case electric field). In this case, the device is able to occupy a conduction state until another electrical stimulus (write/erase) bias is applied. This property is also referred to as conduction switching. The precise reason why such devices show conduction switching has been the subject of investigation for a long time. While several mechanisms may exist depending on factors such as the materials used or the structure of the device, only the charge trap mechanism will be discussed in this work. For more information on this topic, please refer to our comprehensive review of the field.<sup>33</sup> Charge trap mechanism assumes that the nanoparticles play a crucial role in conduction switching by acting as a charge trap; however, several interpretations have been presented over the years to explain the phenomenon. Some of them are discussed as follows.

### Polymer doping model

The polymer doping (PD) model is among the several models that have been proposed to explain the conduction switching



**Fig. 1** Metal-Insulator-Semiconductor (MIS) device structure with Se-NPs as a charge storage medium. Tunnelling layer is  $\text{SiO}_2$  (2 nm), blocking Layer is  $\text{SiN}_x$  (100 nm), charge storage layer is composed of selenium nanoparticles sandwiched between aforementioned dielectric layers deposited on boron-doped P-Silicon wafer ( $1\text{--}10 \text{ Ohm per cm}$ ,  $500 \mu\text{m}$  thickness). Top and bottom ohmic electrodes are made of aluminium (Al).



**Table 1** Summary of fabrication/deposition process parameters used for the fabrication of the device and the respective layers

Material	Fabrication/deposition process
Al bottom ohmic electrode	Thermal evaporation of Al (100 nm) on an unpolished surface (backside), annealed in a furnace under N <sub>2</sub> atmosphere at 550 °C for 30 min.
SiN <sub>x</sub> thin film/layer	Deposited by Plasma Enhanced Chemical Vapor Deposition (PECVD) technique with a 13.56 MHz parallel plate RF-PECVD reactor (Oxford Plasmalab-100). SiN <sub>x</sub> was deposited at temperature = 300 °C, RF power density = 10 mW cm <sup>-2</sup> , pressure = 500 mTorr, duration = 15 min, with the use of following gases: SiH <sub>4</sub> (20 sccm), NH <sub>3</sub> (50 sccm), and N <sub>2</sub> (100 sccm).
Se Nanoparticles	Thermal evaporation of Se at 0.1 nm s <sup>-1</sup> to achieve a mass thickness of 5 nm.
Al electrode	Thermal evaporation of Al at 2 nm s <sup>-1</sup> to achieve a mass thickness of 100 nm.

that occurs in metal nanoparticle-embedded devices. The PD model was reported initially by Ma *et al.*<sup>11,19,34–40</sup> in response to the 6 orders of ON/OFF ratio that was observed in their Al- embedded interlayer.<sup>37</sup> The embedded metal layer was found to be integral in the process of conduction switching as no switching was observed for devices without it.<sup>38,40</sup>

A theoretical model of the device behavior was proposed in 2004, wherein device conduction was assumed to be a hopping model charge transfer.<sup>40</sup> The embedded layer or the interlayer was proposed to bridge the charge transfer by assisting the resonant tunnelling of the charges.<sup>40</sup> The embedded metal layer thickness was found to be tuned to a value below the critical value, proper conduction was found to be inadequate,<sup>35</sup> while exceeding the thickness beyond the critical value was found to cause an exponential decay in the transmission probability.<sup>40</sup> From these calculations and from the observations, conduction switching was coined to be a ‘metal-insulator transition’ process.<sup>38</sup>

The necessity of the metal interlayer in the process was attributed to charge trapping in the metal nanoparticles that must be present in the layer; the redistribution of charge occurring thereafter in the nanoparticles forms positive-negative electronic regions.<sup>38,40</sup> The stored charges in the middle layer lead to the conduction switching of the device by ‘doping the organics’.<sup>38</sup> Similar to the channel formation in a transistor, the ON-state high conduction of the device was due to the doping of the organic layer upon applying a forward bias. However, in the reverse bias, the stored charges are removed, therefore switching the device back to a low conduction OFF-state.

The model was successful in explaining the switching behavior of the device but it failed to consider the role that aluminium oxide played in the process. Also, even though the theoretical treatment was able to predict the conduction behavior of the device, how much of the switching was contributed by the oxide itself still remains largely unclear, especially considering that aluminium oxide was one of the first oxides that were studied for filamentary conduction.<sup>41–43</sup>

### Simmons and verderber (SV) model

The Simmons and Verderber model (or commonly referred to as the SV model) is one of the prominent works in the area of memory devices. The SV model is a mechanism that was proposed more than 50 years ago, when device switching was observed in thin film insulators sandwiched between metal electrodes.<sup>44,45</sup> Owing to a large number of works that

identified the device behavior to the SV model since then,<sup>18,21,46–59</sup> it was found to be essential to discuss the features of this model and how it explores the device switching behavior.

(a) It was observed that when a metal–insulator–metal (MIM) structure was subjected to an electroforming process, multi-stable states could be observed.<sup>60</sup> The electroforming process (commonly referred as simply ‘forming’)<sup>61</sup> included the application of a high electric field (applying a typical voltage of 10 V across a 200 nm thick insulator layer)<sup>59</sup> over a period of few seconds on the positive gold electrode.<sup>62</sup>

(b) The device switching behavior was observed to be an electrode-sensitive process,<sup>44,45</sup> indicating the movement of gold atoms from the electrode into the SiO insulator layer.<sup>59</sup>

(c) The device conduction exhibited an *N*-curve behavior, wherein a local maximum current is obtained, followed by a negative differential resistance (NDR) region and a local minimum current.<sup>5</sup> The SV model states that this kind of behavior is due to the band of impurity levels that are introduced by the gold atoms in the insulator layer. These trap states assist in the conduction increase, but as the traps begin to ‘fill up’, the space-charge build up and begins to oppose further charge injection into the device. The charge storage hypothesis was based on the fact that if the applied field was taken away at or before the point of maximum current, the device retained the state of high conduction.

(d) The device conduction is observed to be virtually temperature-independent.<sup>45</sup> This, however, does not mean that it is completely immune to the change in the temperature; the temperature dependence of the device conduction is just weak. Thus, the tunnelling of charges has been considered to be the conduction mechanism in the device.

The charge storage aspect of the SV model makes it one of the models within the charge trapping mechanisms that have been prominent in the explanation of the device bistability for memory device application. Also, while the success of the SV model in explaining most of the device switching behavior is apparent, there are some open questions that remain unanswered. Under the SV model, as long as the trap levels due to the NPs in the insulator layer remain unoccupied, the trap levels are able to conduct current in the ON-state. The lowering of the current and the NDR region is owing to the filling up of the impurity levels by the charges,<sup>63</sup> and the device switches to the OFF state due to the space-charge field inhibition to the injection of charges.<sup>18</sup> This would, however, predict that a pristine device, which has unoccupied trap states, would initially yield the high conduction ON state. The reason why a pristine device conducts



in the low conduction OFF-state despite the empty states is still an inconsistency in experimental observations.

In the context of the abovementioned points, it must be noted that the SV model in device switching due to charge trapping must be thoroughly investigated in terms of the features that the model addresses.

### Electric field-induced charge transfer

Electric field-induced charge transfer relies on nanoparticle-based switching, but rather than using charge 'storage' to explain the switching conduction states in organic devices, it treats the phenomenon to be due to reversible charge 'transfer'.<sup>22,53,64–67</sup> An example is when PANi was used as the matrix and electron donors, whereas the nanoparticles dispersed in the PANi nanoribbons were used as the electron acceptors. When PANi loses electrons under the influence of a high electric field, it creates vacancies or holes in the polymer matrix. This oxidized state of the polymer due to the excess holes leads to the switching of the device to an enhanced conduction ON-state.<sup>63</sup> On applying a reverse polarity, however, the charges that are trapped in the highest occupied molecular orbital level of the nanoparticles are released back to the polymer nanocomposite; thereby, the polymer switches back to the original low conduction OFF-state. The electric field-induced charge transfer model thus successfully predicts that a pristine device will always switch in the low-conduction OFF state, as confirmed by the experiments.<sup>22</sup>

It must be noted once more that under this model, the insulator plays an active role in conduction through the device. Under the oxidation–reduction process, the organic layer is treated as if it is a modulated conductor, where conduction can be switched back and forth by the creation of vacancies and restoring them. Distinctions must be drawn, however, between the charge-transfer model and the redox-switching model. Redox switching treats the organic layer like a solid electrolyte, wherein the ions generated during the redox reactions migrate through the device cross-section, which is quite distinct from the former.

### Charge trapping and internal field model

Based on the electron-in-a-box model, the internal field model treats nanoparticles as a Coulombic trap, which is embedded within an insulator matrix.<sup>68</sup> Paul<sup>69</sup> employed this treatment to describe the switching behavior observed in C60 and 8HQ in a polystyrene matrix. Since then, many works have attributed the bistable switching device behaviors to this model.<sup>32,69–78</sup> It is necessary, therefore, to examine the details of this model if the features are to be identified and the differences to be recognized. Under this proposed model, the 'write' operation is performed when a write voltage is applied to the device, during which the charges (electrons in this case) tunnel through the insulator barrier and start populating the nanoparticles. The electrons that are injected into the nanoparticles become trapped when the external bias is removed. On the other hand, the 'erase' operation is performed by applying an opposite polarity bias across the device to offer a favorable condition for the trapped electrons to escape the nanoparticles and to revert the state of the device to the initial condition. Further information on this model will be presented along with the device measurements. Various devices have been studied under this model to successfully explain device bistability, including metal nanoparticles,<sup>5,32,70,79–81</sup> macromolecules,<sup>69,76–78,82</sup> ferroelectric nanocomposites,<sup>75,83</sup> nanowires,<sup>71–73</sup> and other organic molecules.<sup>74</sup>

## Results and discussions

### Surface morphology

**Insulator layer – silicon nitride.** The surface morphology of the silicon nitride layer was analyzed using atomic force microscopy (AFM). Fig. 2a shows the topography scan of the insulator layer that was conducted over an area of  $10 \times 10 \mu\text{m}^2$ . The surface roughness was measured, and the RMS surface roughness was approximately 2.486 nm. The high resolution image shown in Fig. 2b depicts grain-like structures,

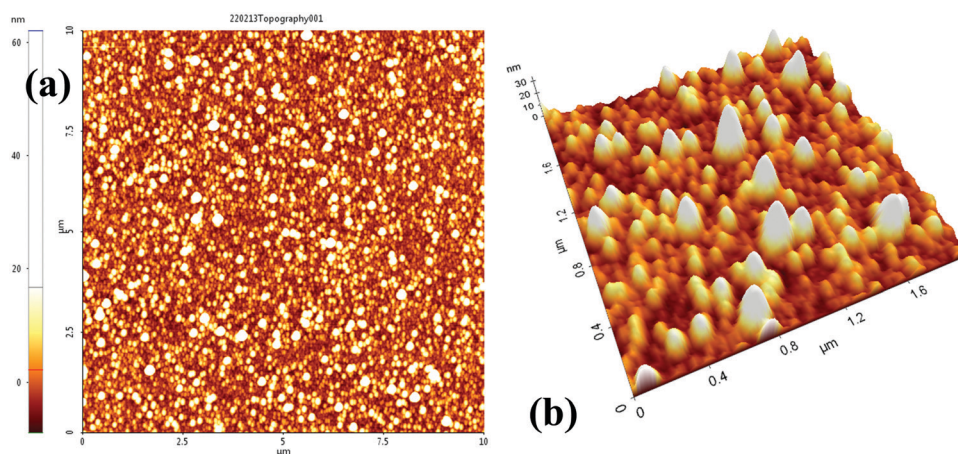


Fig. 2 Topography of the silicon nitride thin film deposited on P-Si wafer covered with tunnel silicon oxide by the PECVD process. (a) Morphology of the surface shows grain-like structures with RMS surface roughness  $R_a = 2.486 \text{ nm}$  (Scanned area  $10 \times 10 \mu\text{m}^2$ ). (b) High resolution 3D-image scanned for an area of  $2 \times 2 \mu\text{m}^2$ .



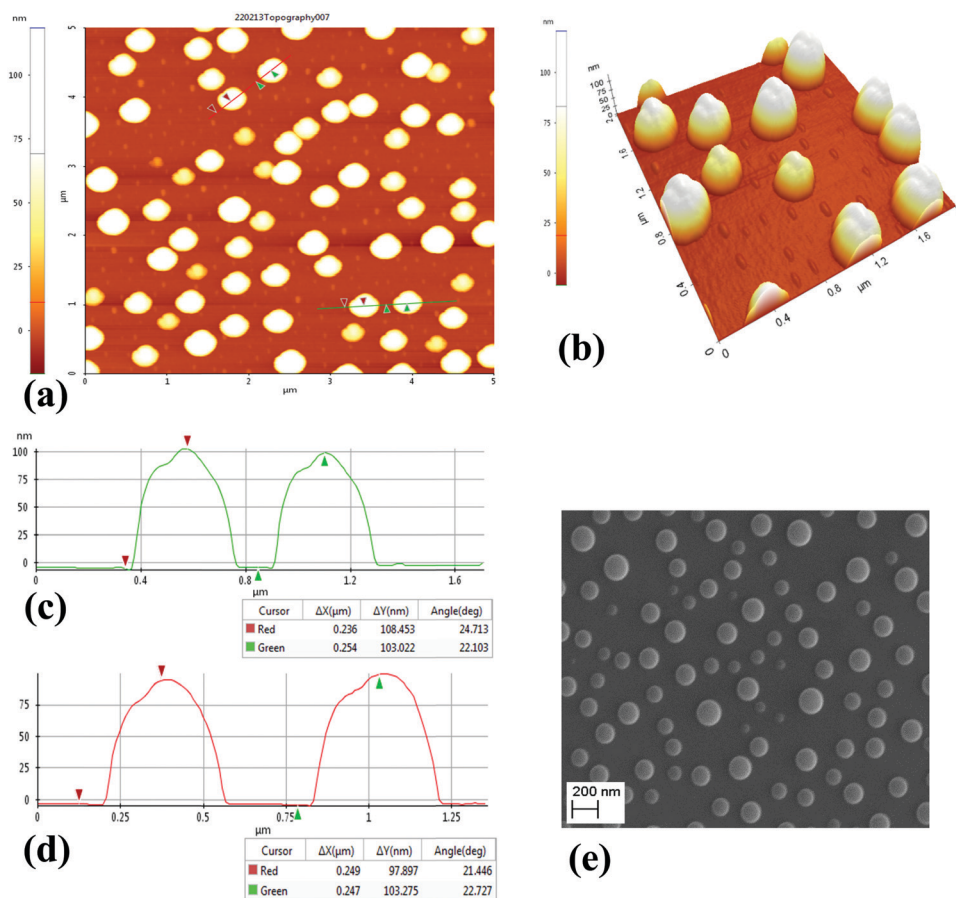
demonstrating that the thin film is mostly likely to be amorphous/polycrystalline.

**Charge storage layer - selenium nanoparticles.** Further morphology analyses were conducted on selenium nanoparticles deposited over Si/SiO<sub>2</sub> wafer to understand the distribution of Se-NPs. The AFM images also provide insight into the size, dimensions, and geometry of nanoparticles. The size of the nanoparticles is relatively uniform with small variability; the radius of the nanoparticles is about 100 nm (see Fig. 3a). A line profile scan over the nearby physically distant nanoparticles revealed a fairly equal nanoparticle diameter. Fig. 3b, c show the line profiling measurements, wherein the nanoparticle radius was found to be 97 nm, 103 nm, 108 nm, averaged to about 100 nm. Another property of nanoparticles was the hemispherical geometry that prevailed throughout the substrate area. Unsurprisingly, these were the result of the collision of the nanoparticles on the substrate surface where the thermally evaporated materials were collected. The morphology of Se nanoparticles deposited over the tunnelling layer is shown in Fig. 3e. Nanoparticles are uniformly distributed and do not touch each other. It is important that the nanoparticles do not touch each other to prevent the leakage of charges among the

nanoparticles. The average diameter of SeNPs is  $\sim 168$  nm and narrow size Gaussian distribution is determined with the ImageJ software with a polydispersity of 5% and a standard deviation of 26 nm. The SEM image clearly reveals that the nanoparticles are almost spherical.

### Current-voltage measurements

The current-voltage ( $I$ - $V$ ) measurements were conducted on two different devices; the reference device without selenium nanoparticles and the device with SeNPs particles were embedded between the dielectric layers. The  $I$ - $V$  behavior of either of these devices was compared in Fig. 4. It was observed that the presence of nanoparticles leads to an enhancement of the hysteresis. This may be caused by two possible reasons. The trap charges in the nanoparticles begin to result in a building up of an internal field. Also, the rougher blocking layer plays an important role. The change in the conduction that is observed in the form of a hysteresis in Fig. 4 is due to the resultant current output either competing against or adding up with the internal field. In this case, the arrow shows the sequence of the measurement; the reverse sweep is therefore found to be more negative than the first voltage sweep. This can be attributed to the electron traps that



**Fig. 3** (a) Topography of selenium (Se) nanoparticles deposited on p-Si wafer covered with tunnel silicon oxide scanned over for an area of  $5 \times 5 \mu\text{m}^2$ . (b) High resolution 3D-image showing the morphology of selenium nanoparticles scanned for an area of  $2 \times 2 \mu\text{m}^2$ . (c and d) Line profile measurements depicting the radius of nanoparticles at two different regions annotated in (a). (e) Morphology of selenium nanoparticles deposited over the tunnelling layer, revealing uniformly distributed nanoparticles.



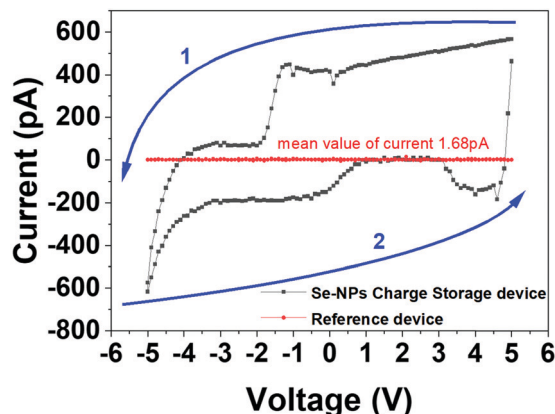


Fig. 4 Current–voltage ( $I$ – $V$ ) characteristics of MIS devices; reference device without Se-NPs (red curve) and with Se-NPs devices (grey curve). For reference, the device mean value of the measured current is 1.68 pA. This assures the quality of the MIS structure for capacitance–voltage ( $C$ – $V$ ) measurements.

generate an internal electric field. This internal electric field's direction is in the same direction as that of the externally applied electric field. Thus, the enhancement of the electrical field increases the current.

The asymmetrical device structure is a deliberate attempt to enhance the tunnelling of charges mostly from one side and discourage conduction from the other side. The nanoparticles are embedded with a thicker insulator layer on one side (called the blocking layer) and a thinner insulator layer on the other side (known as the tunnelling layer) (Fig. 1).

The structure used in this study is very delicate and it is imperative to consider the maximum current that can flow through it. If the current through such structures is below few nanoamperes, the trapping and de-trapping can function well. The further increase in the current by one or two orders (to boost the ON/OFF ratio) can introduce localized heating and result in device structure modification. It can even lead to the coagulation of nanoparticles and soft dielectric breakdown.<sup>84</sup> As the magnitude of current through the device further increases, the electronic conduction can be effected by thermal effect and the associated switching behaviors.<sup>85</sup> The balance between lower values of ON/OFF ratio is therefore considered very carefully to ensure reliability and repeatability in CV measurements, which are divided into two distinct sections that focus on different parameters. First, the effect of the applied DC bias was analyzed (Section 4.3.1), and the effect of the variable frequency of applied AC bias is the second focus (Section 4.3.2).

**Effect of applied DC voltage.** The magnitude of applied bias on the gate (top electrode) determines the charge accumulation in the p-type silicon substrate. It was observed that the CV curve in the SeNP devices, followed an anticlockwise direction, whereby accumulation occurred when a negative bias was applied to the top electrode. In the same manner, when a positive bias was applied to the top electrode, inversion was observed as expected for a p-type silicon substrate. Observing these trends, as seen in Fig. 6a, the inversion region occurs when a positive bias is applied and the electrons are pushed closer to tunnelling; consequently,

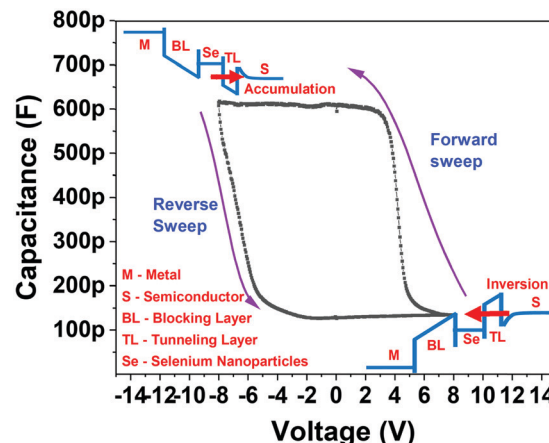


Fig. 5 Capacitance–voltage behavior of selenium nanoparticle-based charge storage memory device. Arrows show the sequence of the measurement. Trapping and de-trapping of charges in the accumulation and inversion region, respectively, have been detailed in the illustration.

they tunnel into the nanoparticle through the tunnel layer (Fig. 5). This simulates the effect as seen by fixed impurities and leads to the shifting of the CV curve in reverse sweep. As the reverse sweep reaches accumulation, the trapped charges are expelled from the nanoparticles.

This process, as can be expected, is sensitive to the magnitude of the applied bias and the width of the sweep window. This dependence was tested by progressively increasing the sweep window from  $\pm 1$  V to  $\pm 10$  V. The resultant CV curve have been plotted in Fig. 6a. The device achieves accumulation at about  $-2$  V and then the accumulation capacitance extends until  $-10$  V. The magnitude of accumulation capacitance was separately analyzed and plotted (refer Fig. 6b). A variation of 20 pF was observed in the accumulation capacitance through a range of incremental biases. This variation is acceptable; however, a greater degree of variation would point toward an onset of dielectric breakdown or trap states within the insulating layer. These measurements therefore affirm the dielectric stability under the range of applied DC-bias.

The hysteresis in the CV curve with varying bias was calculated using the flatband shift ( $\delta V$ ); this was estimated by evaluating the difference between the forward sweep voltage ( $V_+$ ) and the reverse sweep voltage ( $V_-$ ), as can be seen in Fig. 6a.<sup>86</sup> As expected, the flatband shift is a function of the trapped charge (refer Fig. 6c).<sup>87</sup>

Furthermore, the number of trapped charges were calculated per unit area ( $n$ ) per unit area using the following relation

$$n = \frac{C_{\text{acc}} \delta V}{qA} \quad (1)$$

where,

$$\delta V = |V_r - V_f| \quad (2)$$

$C_{\text{acc}}$  is the value of the accumulation capacitance,  $q$  is the charge of electron,  $\delta V$  is the difference in the flatband voltage shift, and  $A$  is the area of the top-gate electrode.<sup>72</sup>



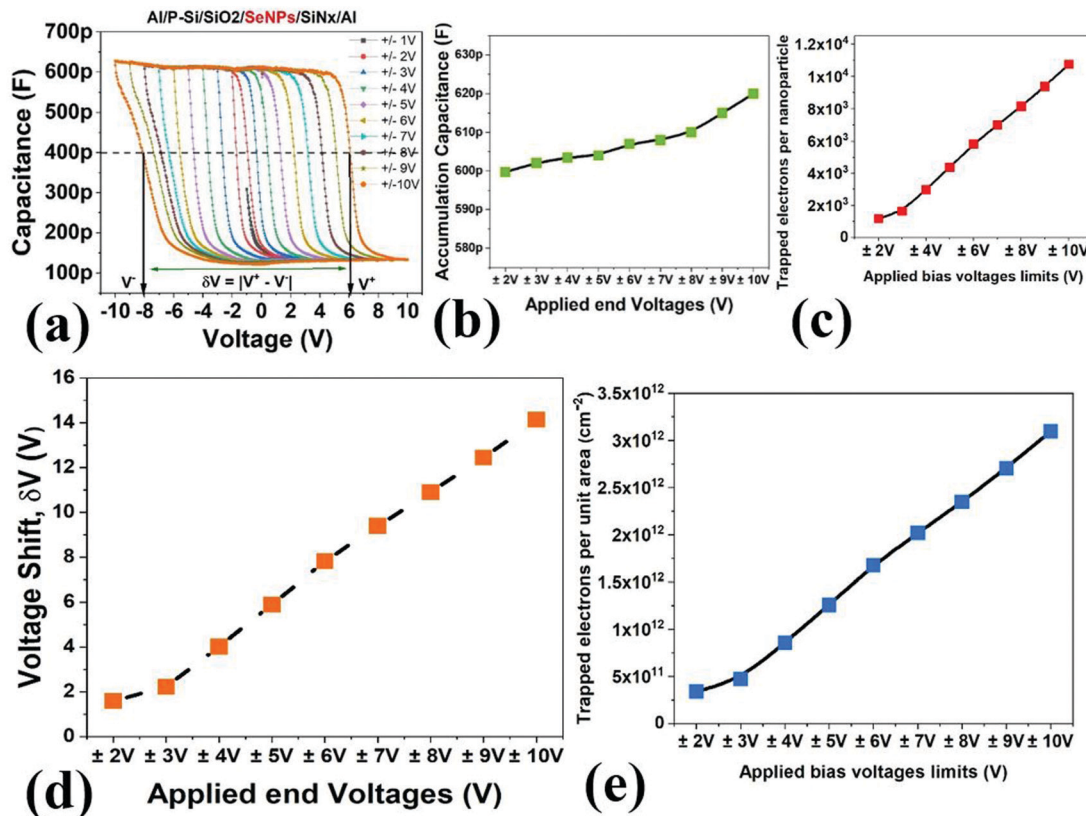


Fig. 6 (a) Capacitance–voltage (CV) characteristics as a function of the DC bias sweep window (from  $\pm 1$  V to  $\pm 10$  V) for the SeNPs charge storage device. During these measurements, the AC voltage was fixed at 100 mV rms at 500 kHz. (b) Accumulation capacitance plot against the sweep window, (c) number of trapped electrons per nanoparticle plotted against applied bias. (d) Flatband voltage shift plotted as a function of sweep window, and (e) electron density/area against the sweep window.

The trap charges per unit area was obtained and is plotted in Fig. 6d, which shows a direct proportionality relationship with the magnitude of the applied bias. As the bias voltage is increased, the magnitude of the tunnelled charges increases and, consequently, the trap charges density increases. By estimating the number of electrons trapped per unit area and the number of nanoparticles per unit area, we calculated the total number of electrons trapped in a single nanoparticle. As the number of trapped electrons is a function of applied voltage, it was calculated and plotted for different bias voltages, as shown in Fig. 6c. However, it must be noted that the accuracy of the trapped electrons per nanoparticle may be affected by additional factors such as trapping of electrons in the insulator, or varying nanoparticle distribution density and spread of Gaussian distribution of the nanoparticle diameter. In our calculations, we have assumed that all the electrons, which tunnel through the oxide layer, are stored on the nanoparticles.

**Effect of frequency of applied AC voltage.** This section will focus on the effect that the varying frequency of the applied AC signal has on the capacitance measurement. Fig. 7 shows the CV curves of the (a) reference device and (b) the device containing Se-NPs. The comparison of the CV curve is quite evident, wherein Fig. 7a shows minimum hysteresis in the forward sweep (+5 V to −5 V) and the reverse sweep (−5 V to +5 V),

while the SeNP devices show significantly higher hysteresis (refer to Fig. 7b). This behavior further confirms that electron trapping is evident in the device (Fig. 7b), which is otherwise observed to be absent in the reference device (Fig. 7a). The *I*–*V* and *C*–*V* measurements that compare the reference and the nanoparticle-embedded devices prove that the behavior observed here is not due to a parasitic contribution from the other dielectric layer but indeed due to the charge trapping tendency of the Se nanoparticles.

The flatband shift was calculated for the CV measurements, wherein the shift magnitude was calculated for varying frequencies (refer to Fig. 8c). The flatband shift was found to be affected by the frequency; the shift window was observed to decrease as the frequency of the applied AC signal increased. The reduction of the flatband voltage can point toward a reduction in the number of tunnelling charges. The accumulation capacitance value drops in the same manner as the reduction in the flatband voltage. However, the dip in the accumulation capacitance begins to occur much earlier. Fig. 8b shows a reduction of about 50% as the frequency is reduced from 10 kHz to 100 kHz. This could be due to the response by the dielectric layer at the frequency, which leads to an overall reduction in the capacitance of the system<sup>88</sup> and inherent deep-energy states within the dielectric energy gap. These deep-energy states can be a



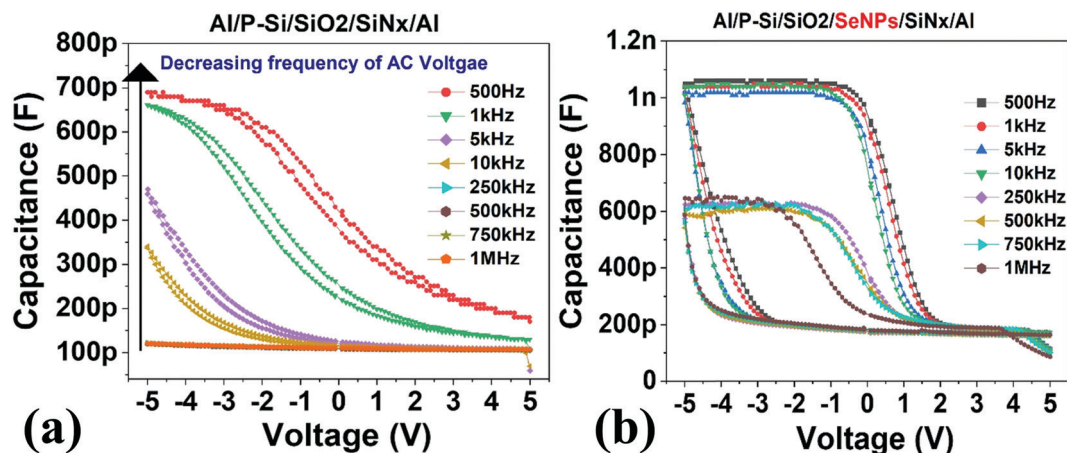


Fig. 7 Capacitance–voltage characteristics of the (a) reference device and (b) charge storage device containing Se-NPs. The measurements were conducted at 100 mV rms.

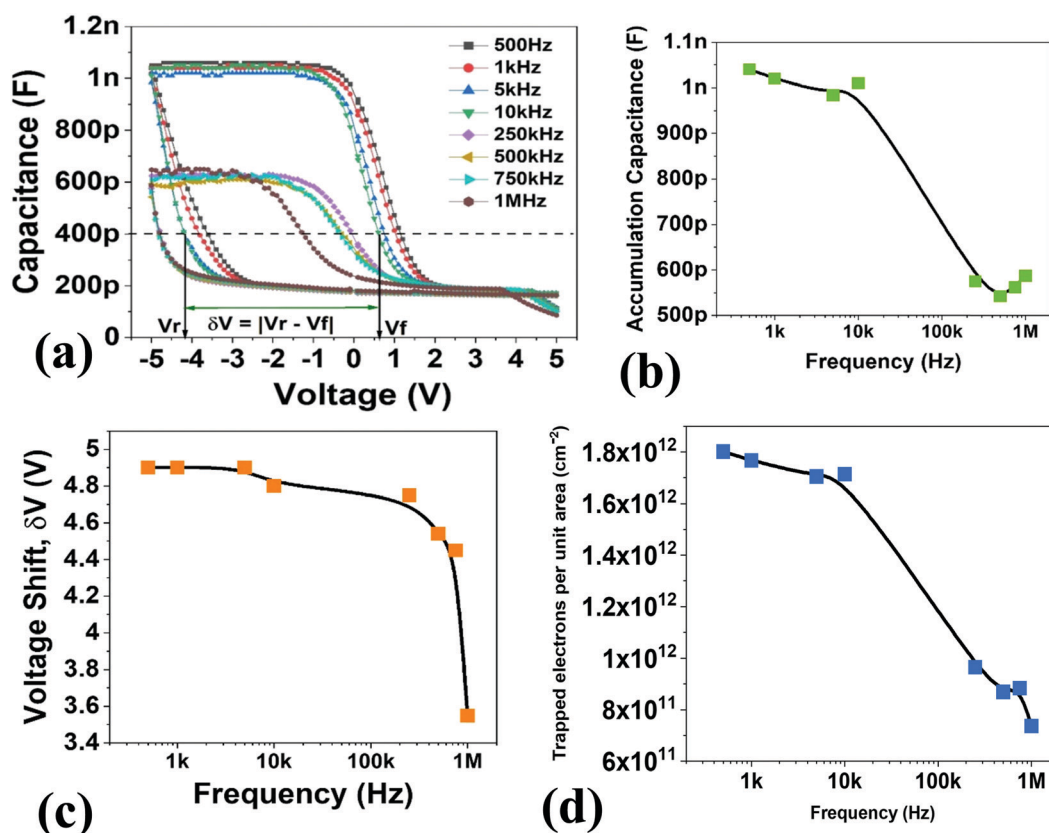


Fig. 8 (a) Capacitance–voltage characteristics as a function of applied AC voltage frequency for the charge storage device measured at 100 mV rms. (b) Deduced accumulation capacitance, (c) voltage shift, and (d) electron density/area at different frequencies.

function of the frequency and they may not respond to a higher frequency.

Apart from the accumulation capacitance and the flatband voltage shift, it was observed that the trap density also reduced as the frequency increased (refer to Fig. 8d). Contributing factors from the slower charge impurities and the dielectric response of the device might lead to a reduction in the trap

charge density per unit area. The frequency of the applied bias is therefore a parameter that must be considered carefully for optimum performance.

#### Retention ( $C-t$ ) measurement

The retention measurements were also conducted, as shown in Fig. 9a. The measurements were conducted at a read voltage of



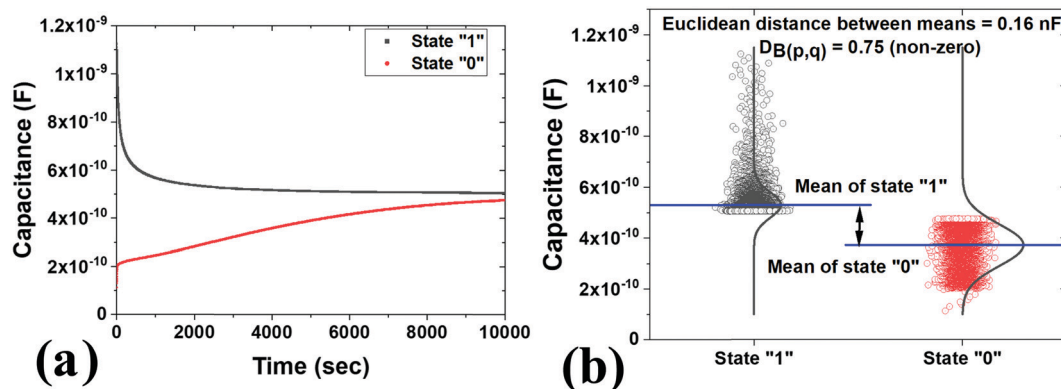


Fig. 9 Charge retention data of charge storage undertaken over a period of time. Charge was stored (data write) by applying +5 Vdc and removed (data-erase) by applying 5 Vdc, stored charge was measured (data-read) at 0.1 Vdc and 100 mV rms set at 500 kHz. (b) An interval plot showing state "1" and state "0"; the plot provides information whether the two states have similar mean values and also provides a comparison of the amount of variation present in each state. We assumed normal distribution, for simplicity, in each state for determining the Euclidean and Bhattacharyya distance.

0.1 Vdc, while writing at  $-5$  Vdc and erasing at  $+5$  Vdc were carried out. The effective trapping of electrons results in the build-up of an internal field within the device. It is this internal field that the 'read' operation relies on to distinguish one state from the other. The 'read' operation is performed by applying the same bias that is optimized to be small enough to not influence the state of the system but still large enough to obtain a distinguishable difference between the two states. Finding an optimum value for the read bias is crucial; if it is too large, the reading of the states ("0" or "1") will influence the escape of the trapped electrons, thereby affecting the state of the system. If it is too small, distinguishing one state from the other becomes difficult. The read bias serves primarily to be employed as a test charge to detect the presence or absence of charges in the nanoparticles. In case of presence of trapped electrons, the application of the read bias results in a small yet considerable difference in the device conduction. In this case, distinct states were observed even up to 10 000 seconds. The loss of the charges could be due to the denser distribution of the nanoparticles, wherein a few nanoparticles are in contact with each other, which leads to charge coupling and accelerates the leaking of the charges.<sup>89</sup> The appropriate thickness of the tunnel layer must also be further optimized. Fig. 9b shows the scatter interval plot of state "1" and state "0". It is just to show that the two states distinguish themselves over 10 000 seconds. The Euclidean distance between the state means and the Bhattacharyya ((DB(p,q)) distance is nonzero; therefore, the states are distinguishable.

## Conclusion

In this study, selenium nanoparticles embedded in insulating matrix devices were tested and studied to identify the evidence of charge storage. The presence of nanoparticles was found to be essential for electrical switching between two conductive states. The  $I$ - $V$  and  $C$ - $V$  curve also evidenced an enhanced hysteresis in the SeNP devices; a minimum hysteresis was observed in the reference device. The flatband voltage shift was found to have a proportional relationship with the bias voltage. The accumulation

capacitance maintained a fairly steady value through the range of bias sweep window, indicating no dielectric breakdown. The trap charge density and the flatband voltage, however, reduced as the frequency of the applied AC signal increased. This is attributed to the presence of deep energy states within the insulating nanoparticles, being unable to follow a higher applied frequency. Retention measurement was conducted for the MIS device, demonstrating distinct capacitance states. Both the Euclidean and Bhattacharyya distance are nonzero; thus, the states ("0" and "1") are distinguishable.

## Conflicts of interest

There are no conflicts to declare.

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